



MOSFET

OptiMOS[™] 5 Power-Transistor, 60 V

Features

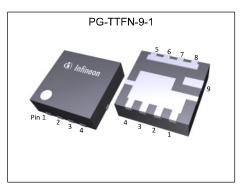
- Optimized for synchronous rectification
- 100% avalanche testedSuperior thermal resistance
- N-channel, normal level
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

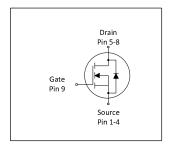
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	60	V
RDS(on),max	3.0	mΩ
ID	137	A
Q _{oss}	42	nC
Q _G (0V10V)	39	nC









Type / Ordering Code	Package	Marking	Related Links
IQE030N06NM5CG	PG-TTFN-9-1	03006C5	-



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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

Deveryor	C. makes		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D			137 97 21	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =10V, T_{A} =25°C, R_{thJA} =60°C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	547	А	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	EAS	-	-	153	mJ	I _D =20 A, R _{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	107 2.5	w	$T_{\rm C}=25 \ ^{\circ}{\rm C}$ $T_{\rm A}=25 \ ^{\circ}{\rm C}, \ R_{\rm thJA}=60 \ ^{\circ}{\rm C/W}^{2)}$
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Deveneter	Values				linit	Note / Toot Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	1.4	°C/W	-
Device on PCB, 6 cm² cooling area ²⁾	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Demonstration (1997)	O	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.1	2.8	3.3	V	V _{DS} =V _{GS} , <i>I</i> _D =50 μA
Zero gate voltage drain current	I _{DSS}	-	0.5 10	1.0 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.2 3.3	3.0 5.0	mΩ	V _{GS} =10 V, <i>I</i> _D =20 A V _{GS} =6 V, <i>I</i> _D =5 A
Gate resistance	R _G	-	0.9	-	Ω	-
Transconductance	g _{fs}	-	120	-	S	V _{DS} ≥2 I _D R _{DS(on)max} , I _D =64 A

Table 5Dynamic characteristics

Devementer	Cumple al	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	2900	3800	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	600	780	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	37	65	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	10	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Rise time	tr	-	5.7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	t _{d(off)}	-	18.8	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	5.7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω

Table 6 Gate charge characteristics²⁾

Parameter	0 militad		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	12.2	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	8.1	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	6.8	10.2	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Switching charge	Qsw	-	10.9	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	39	49	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.2	-	V	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	35	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	42	56	nC	V _{DS} =30 V, V _{GS} =0 V

¹⁾ Defined by design. Not subject to production test.
²⁾ See "Gate charge waveforms" for parameter definition

OptiMOS[™] 5 Power-Transistor, 60 V IQE030N06NM5CG



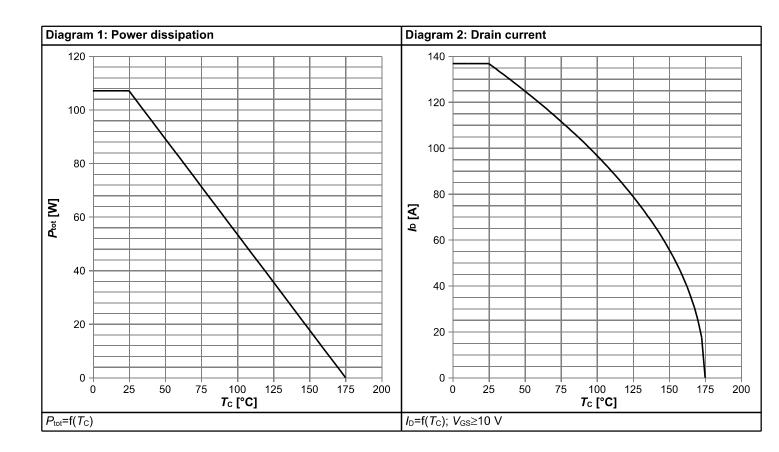
Table 7Reverse diode

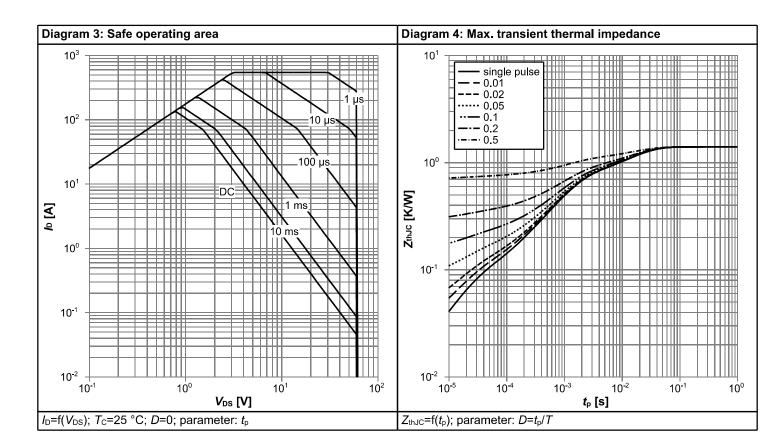
Deremeter	Symbol		Values			Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	ls	-	-	72	А	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	547	А	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.82	1.2	V	$V_{GS}=0$ V, $I_{F}=20$ A, $T_{j}=25$ °C
Reverse recovery time ¹⁾	t _{rr}	-	31	62	ns	V _R =30 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	26	52	nC	V _R =30 V, <i>I</i> _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

¹⁾ Defined by design. Not subject to production test.

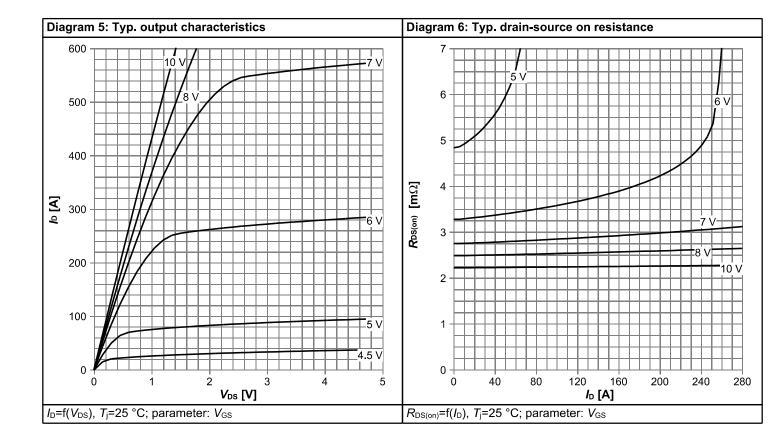


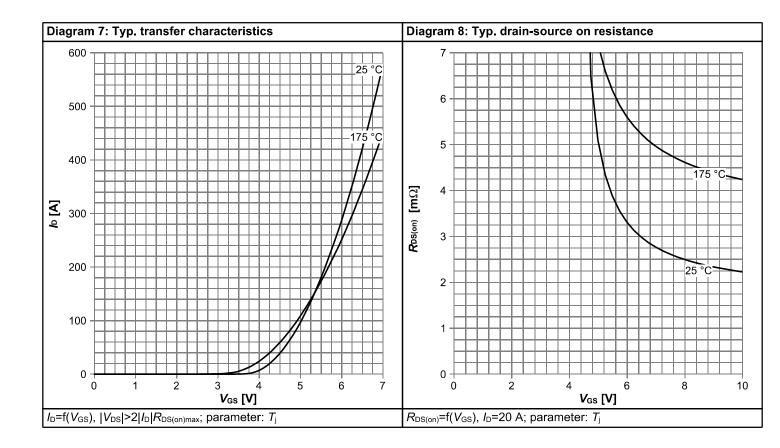
4 Electrical characteristics diagrams



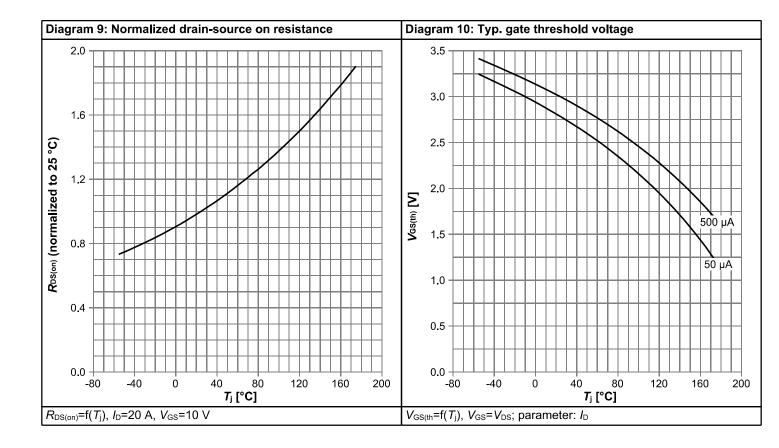


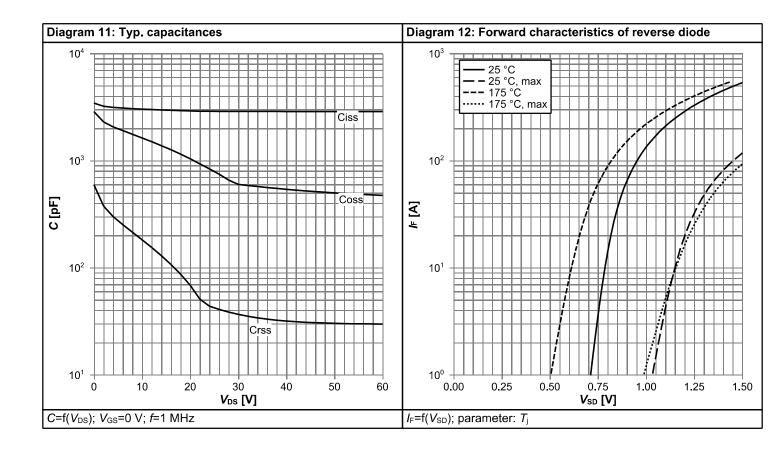




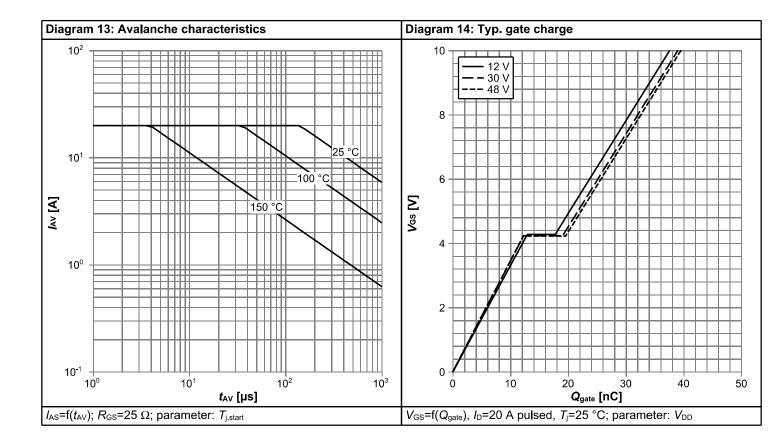


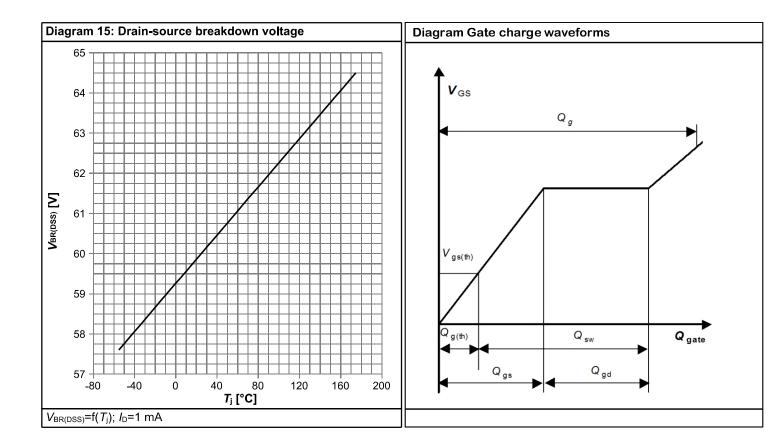






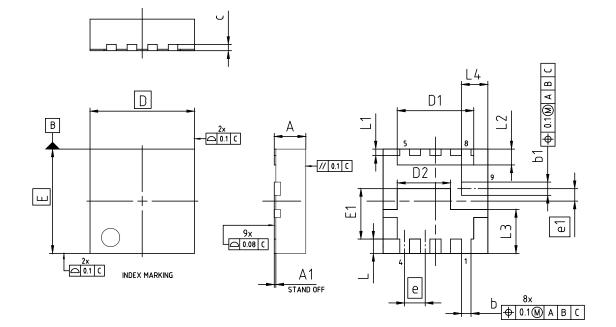








5 Package Outlines



DIMENSION	MILLIM	ETERS				
DIMENSION	MIN.	MAX.				
A	-	1.10				
A1	-	0.05				
b	0.20	0.40				
b1	0.32	0.52				
С	0.	20				
D	3.30					
D1	2.31	2.51				
D2	1.58	1.78				
E	3.30					
E1	1.50	1.70				
e	0.65					
e1	0.395					
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.285	1.485				
L4	0.73	0.93				

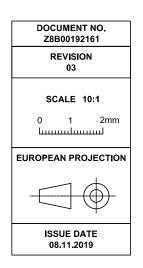


Figure 1 Outline PG-TTFN-9-1, dimensions in mm



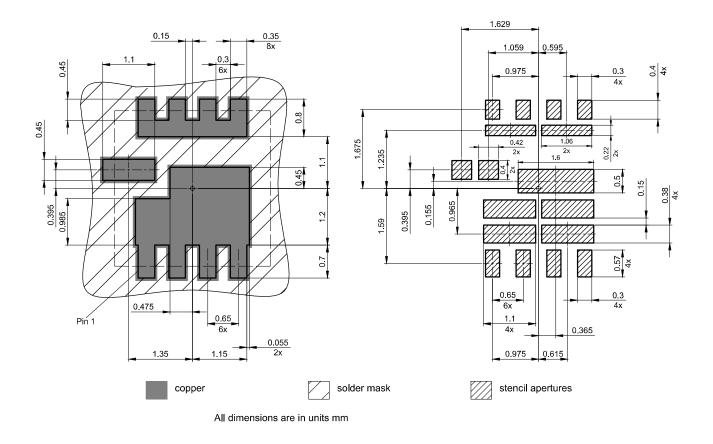


Figure 2 Outline Boardpad (PG-TTFN-9-1), dimensions in mm



Revision History

IQE030N06NM5CG

Revision: 2021-04-27, Rev. 2.0

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2021-04-27	Release of final version				

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